

# SPECIFICATION

ITEM: DIELECTRIC CERAMIC FILTER  
PART NUMBER: CF-25600105

ISSUED	CHECKED	CHECKED	CHECKED	APPROVED

**FILTRONETICS Inc**

**1. APPLICATION**

THIS SPECIFICATION APPLIES TO A BAND PASS FILTER USING DIELECTRIC RESONATORS.

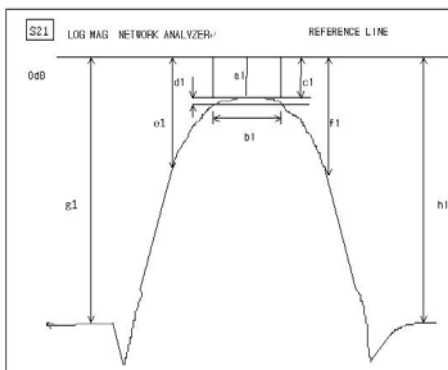
**2. PART NUMBER**

PART NO	CF-25600105
PACKAGING	PLASTIC TRAY

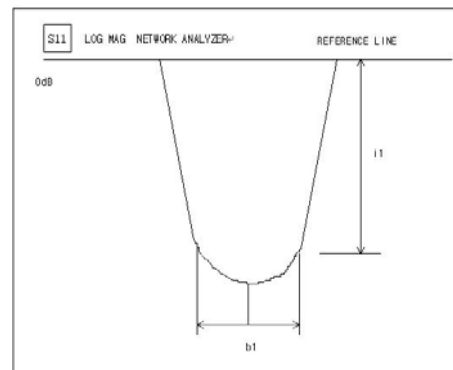
**3. SPECIFICATIONS**

NO	ITEMS	Ref.	SPECIFICATION
1	Center Frequency (Fo)	a1	2560 MHz
2	1.0dB Band Width	b1	10 MHz min
3	Insertion Loss AT Fo	a1	5.0 dB Max
4	V.S.W.R AT Fo+/-5MHz	-	1.75:1 Min
5	Attenuation [absolute value]	At 1920 MHz	55 dB Min
		At 3200 MHz	55 dB Min
6	Impedance	-	50 Ω
7	Maximum Input Power	-	1 W (+30dBm)
8	Operating Temperature Range	-	-30 ~ +75 °C
9	Workmanship	-	IPC-610 class 3
10	Processing Temp	-	+150°C for 1 hour
		-	+230°C for 10 minutes

**S21 LOG MAG NETWORK ANALYZER**

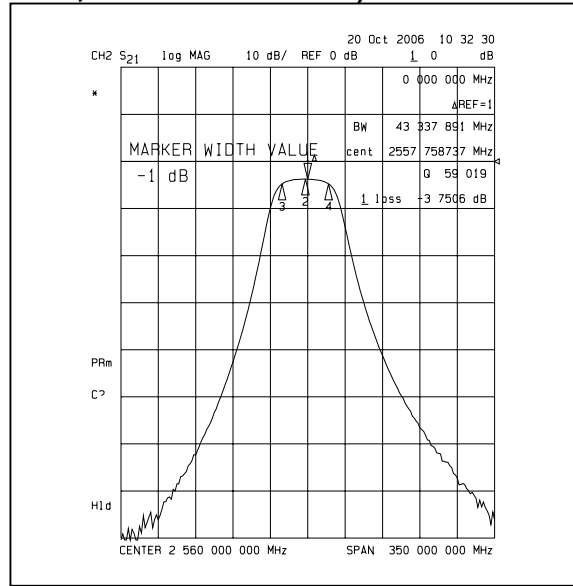
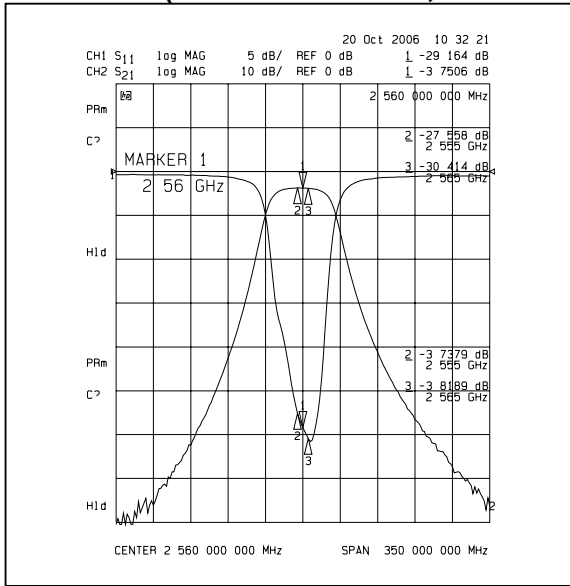


**S11 LOG MAG NETWORK ANALYZER**

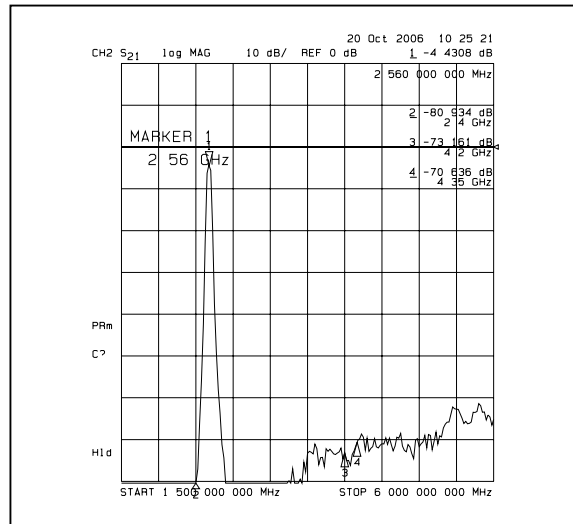
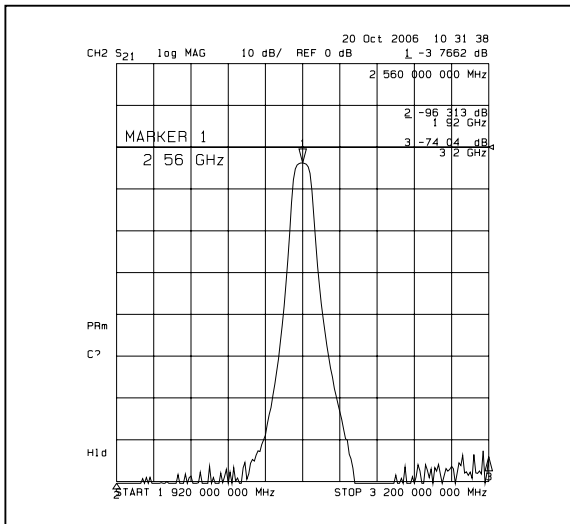


4. GRAPHS

S21 vs S11 (INSERTION LOSS, RETURN LOSS, 1DB BAND WIDTH)

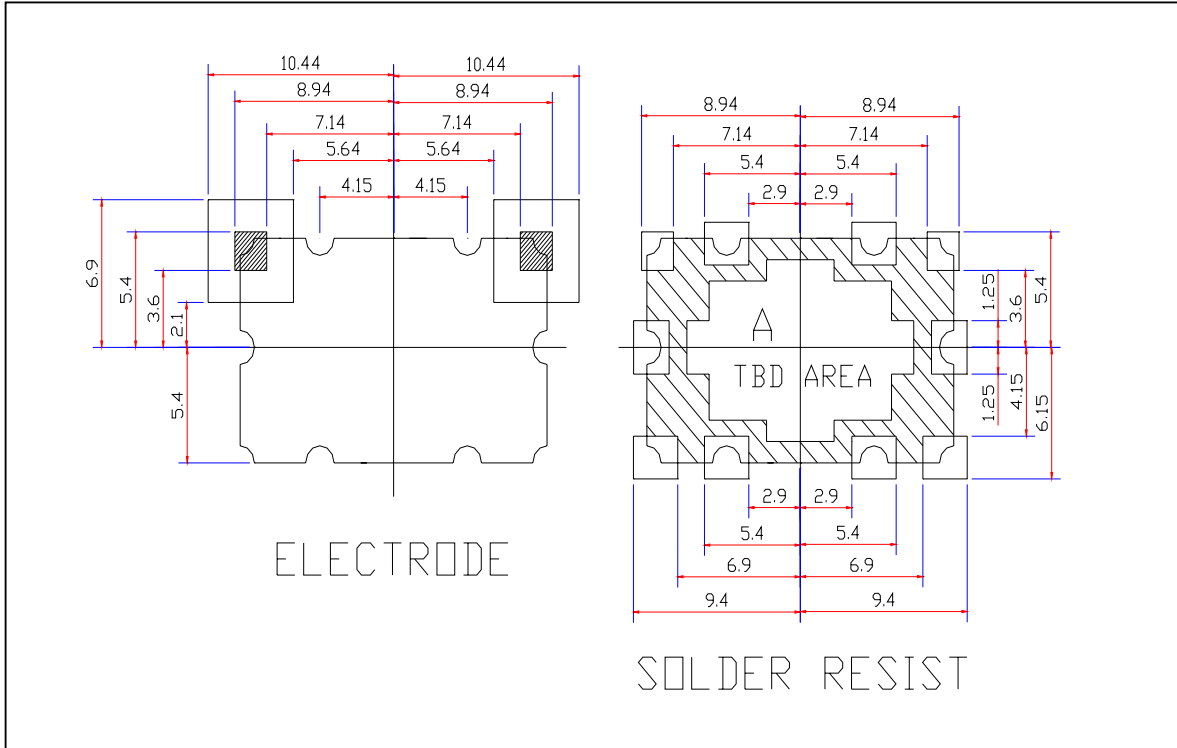


S21 ( ATTENUATION)





Recommended Solder Pattern:



<p align="center"><b>Quality Conformance Test 100% Final inspection</b>  <b>100% Test Data</b></p>	
1)	Visual mechanical to IPC-610 Class 3 Including inspection for cleanliness.
2)	Thermal Shock -44 to +85°C 10 cycles
3)	Electrical Specifications at ambient

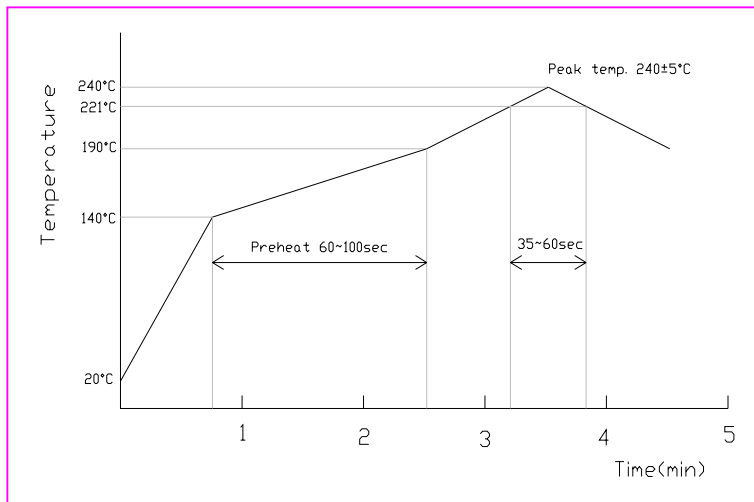
**6. DEFINITIONS**

TERMS	DESCRIPTION	SPECIFICATION
Center Frequency	The midpoint of through band pass filter pass band, normally expressed as the arithmetic mean of the -3db point. Also called $f_0$ .	3. SPECIFICATION
Pass Band Width	The width of the pass band of a filter referenced to the minimum insertion loss point in the pass band. The pass band of a filter is stated as -1.0dB bandwidth.	
Insertion Loss	The loss of the filter, in db, measured at center frequency relative to a through line (0 dB).	
Attenuation	Reduction of RF power through a filter measured in dB, at desired band and referenced to 0 dB. (Filter to be removed from circuit)	
Pass Band Ripple	Variations in loss in the pass band of the filter, superimposed upon the fundamental shape of the pass band.	
V.S.W.R in Pass Band	The ratio of the maximum value of a standing wave to its minimum value, related to the return loss in pass band.	

## 7. RELIABILITY TEST AND CONDITIONS

ITEM	TEST CONDITIONS	REQUIREMENTS
Resistance to solder heat	Preheat temperature : 120 to 150°C Preheat time: 1 to 1.5 min Solder temperature: 260 +/- 10°C Dipping time: 10 +/- 0.5 sec	No damage such as cracks should be caused in chip element.
Solderability	Preheat temperature: 120 to 150°C Preheat time: 1 to 1.5 min Solder temperature: 235 +/- 5°C Dipping time: 5 +/- 1 sec	More than 80% of the terminal electrode shall be covered with new solder
Heat resistance (High-temperature Load)	Temperature: 85 +/- 2°C Applied voltage: Rated voltage Applied current: Rated current Recovery: 1 to 2hrs of recovery under the standard condition after the removal from test chamber.	No mechanical damage. After test, the device shall satisfy the specification in section 3.
Thermal shock (Temperature cycle)	Conditions for 1 cycle Step 1: + 85°C 15 min Step 2 : - 30°C 15 min Number of cycle: 10	No mechanical damage. After test, the device shall satisfy the specification in section 3.
Humidity Resistance	Temperature: 40 +/- 2°C Humidity: 90 to 95% RH Duration: 96 +/- 5 hrs Recovery: 1 to 2hrs of recovery under the standard condition after the removal from test chamber.	No mechanical damage. After test, the device shall satisfy the specification in section 3.
Vibration	Frequency: 10 ~ 50 Hz Amplitude: 1.52 mm ( 0.060 inches) Direction: X, Y and Z Time: each 30 min for all directions	No mechanical damage. After test, the device shall satisfy the specification in section 3.

## 8. REFLOW SOLDERING STANDARD CONDITIONS



- Measuring point of temperature in-out terminals of the device.
- Reflow Soldering
- Both convection and infrared rays
- Hot air
- Solder Cream: Sn96.5/Ag3.5